PD - 94998

International

IRLZ24NPbF

- Logic-Level Gate Drive
- Advanced Process Technology
- Dynamic dv/dt Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Lead-Free

Description

Fifth Generation HEXFETs from International Rectifier utilize advanced processing techniques to achieve the lowest possible on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient device for use in a wide variety of applications.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 watts. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.

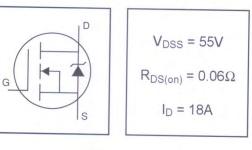
Absolute Maximum Ratings

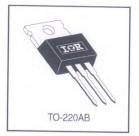
	Parameter	Max.	Units
$I_D @ T_C = 25^{\circ}C$	Continuous Drain Current, V _{GS} @ 10V	18	onito
$I_D @ T_C = 100°C$	Continuous Drain Current, V _{GS} @ 10V	13	A
IDM	Pulsed Drain Current ①	72	^
$P_D @T_C = 25^{\circ}C$	Power Dissipation	45	W
	Linear Derating Factor	0.30	W/°C
V _{GS}	Gate-to-Source Voltage	±16	V
E _{AS}	Single Pulse Avalanche Energy ②	68	mJ
I _{AR}	Avalanche Current①	11	A
E _{AR}	Repetitive Avalanche Energy①	4.5	mJ
dv/dt	Peak Diode Recovery dv/dt ③	5.0	V/ns
TJ	Operating Junction and	-55 to + 175	V/115
T _{STG}	Storage Temperature Range		°C
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	
	Mounting torque, 6-32 or M3 screw.	10 lbf+in (1.1N+m)	

Thermal Resistance

	Parameter	Min.	Тур.	Max.	Units
R _{0JC}	Junction-to-Case			3.3	
R _{0CS}	Case-to-Sink, Flat, Greased Surface		0.50	0.0	°C/W
R _{0JA}	Junction-to-Ambient			62	- 0/00

HEXFET[®] Power MOSFET





	Parameter	Min.	Тур.	Max.	Units	Conditions
V(BR)DSS	Drain-to-Source Breakdown Voltage	55			V	V _{GS} = 0V, I _D = 250µA
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.061		V/°C	Reference to 25°C, I _D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance		-	0.060		V _{GS} = 10V, I _D = 11A ④
			_	0.075	Ω	V _{GS} = 5.0V, I _D = 11A ④
		-		0.105		V _{GS} = 4.0V, I _D = 9.0A ④
V _{GS(th)}	Gate Threshold Voltage	1.0		2.0	V	V _{DS} = V _{GS} , I _D = 250µA
g _{fs}	Forward Transconductance	8.3			S	$V_{DS} = 25V, I_D = 11A$
IDSS	Drain-to-Source Leakage Current			25		V _{DS} = 55V, V _{GS} = 0V
				250	μA	V _{DS} = 44V, V _{GS} = 0V, T _J = 150°C
1	Gate-to-Source Forward Leakage			100		V _{GS} = 16V
GSS	Gate-to-Source Reverse Leakage			-100	nA	V _{GS} = -16V
Qg	Total Gate Charge			15		$I_{\rm D} = 11$ A
Q _{gs}	Gate-to-Source Charge			3.7	nC	$V_{DS} = 44V$
Q _{gd}	Gate-to-Drain ("Miller") Charge			8.5	í	V _{GS} = 5.0V, See Fig. 6 and 13 ④
t _{d(on)}	Turn-On Delay Time		7.1			$V_{DD} = 28V$
tr	Rise Time		74			$I_D = 11A$
d(off)	Turn-Off Delay Time		20		ns	$R_{G} = 12\Omega, V_{GS} = 5.0V$
f	Fall Time		29			$R_D = 2.4\Omega$, See Fig. 10 @
-	Internal Drain Inductance		4.5		- nH	Between lead,
LD	internal Drain Inductance	_	4.5	_		6mm (0.25in.)
-S	Internal Source Inductance	_	7.5		III	from package and center of die contact
Ciss	Input Capacitance		480			$V_{GS} = 0V$
Coss	Output Capacitance		130		pF	$V_{DS} = 25V$
Crss	Reverse Transfer Capacitance		61		P.	f = 1.0MHz, See Fig. 5

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions	
Is	Continuous Source Current (Body Diode)	-	_	18		MOSFET symbol	
I _{SM}	Pulsed Source Current (Body Diode) ①	-		72	A	integral reverse p-n junction diode.	
VSD	Diode Forward Voltage			1.3	V	T _J = 25°C, I _S = 11A, V _{GS} = 0V ④	
t _{rr}	Reverse Recovery Time		60	90	ns	$T_J = 25^{\circ}C, I_F = 11A$	
Qrr	Reverse RecoveryCharge		130	200	nC	di/dt = 100A/µs ④	
t _{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by L _S +L _D)					

Notes:

- Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)

 $\label{eq:ISD} \begin{array}{l} \textcircled{3} I_{SD} \leq 11A, \mbox{ di/dt} \leq 290A/\mu s, \mbox{ } V_{DD} \leq V_{(BR)DSS}, \\ T_J \leq 175^{\circ}C \\ \textcircled{3} Pulse \mbox{ width} \leq 300\mu s; \mbox{ duty cycle} \leq 2\%. \end{array}$



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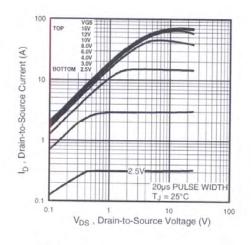


Fig 1. Typical Output Characteristics

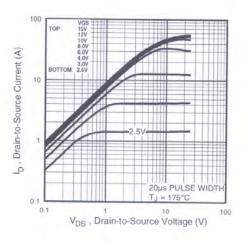


Fig 2. Typical Output Characteristics

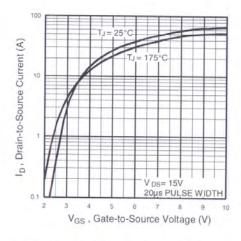


Fig 3. Typical Transfer Characteristics

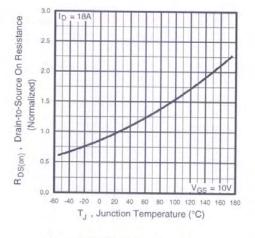
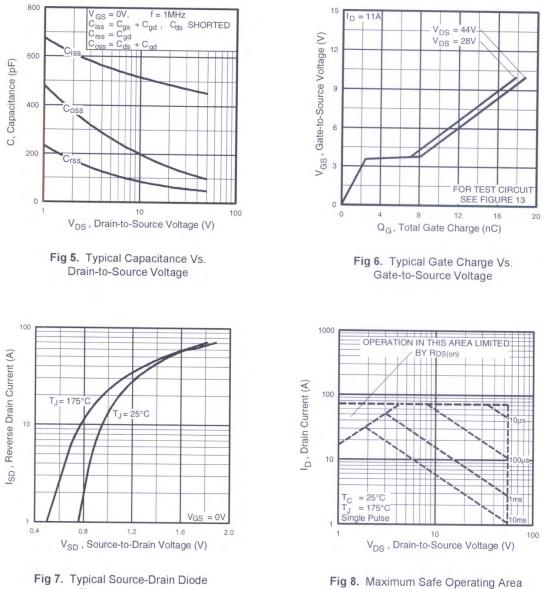
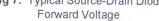


Fig 4. Normalized On-Resistance Vs. Temperature

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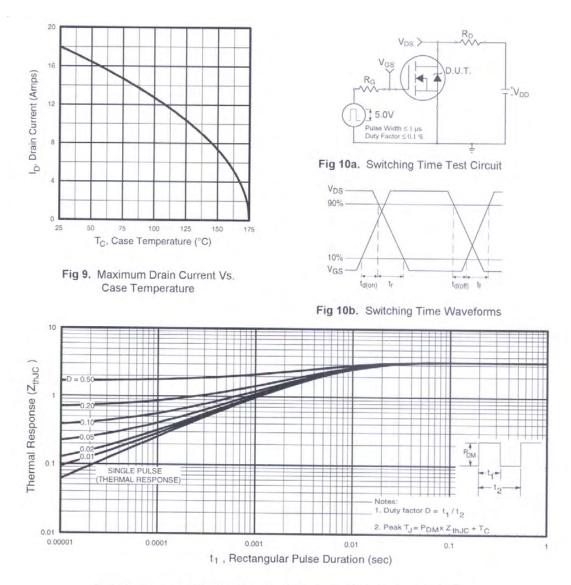


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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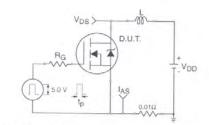


Fig 12a. Unclamped Inductive Test Circuit

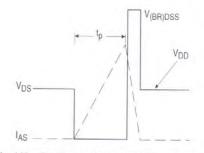


Fig 12b. Unclamped Inductive Waveforms

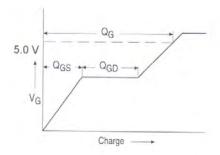


Fig 13a. Basic Gate Charge Waveform

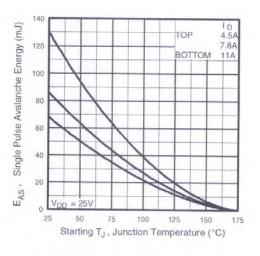


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

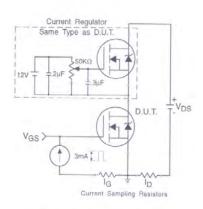
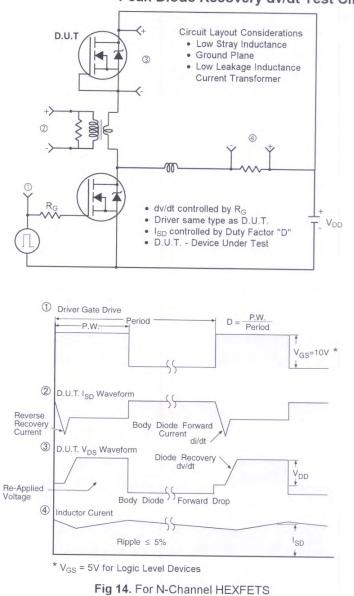


Fig 13b. Gate Charge Test Circuit

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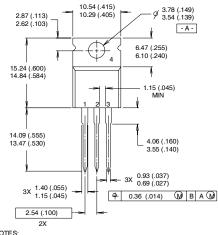


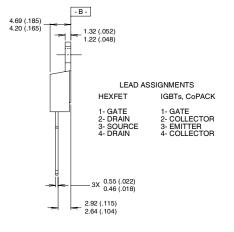
Peak Diode Recovery dv/dt Test Circuit

International TOR Rectifier

TO-220AB Package Outline

Dimensions are shown in millimeters (inches)





NOTES:

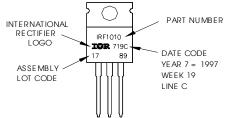
1 DIMENSIONING & TOLERANCING PER ANSI Y14.5M, 1982. 2 CONTROLLING DIMENSION - INCH

3 OUTLINE CONFORMS TO JEDEC OUTLINE TO-220AB. 4 HEATSINK & LEAD MEASUREMENTS DO NOT INCLUDE BUBBS

TO-220AB Part Marking Information

EXAMPLE: THIS IS AN IRF1010 LOT CODE 1789 ASSEMBLED ON WW 19, 1997 IN THE ASSEMBLY LINE "C"

Note: "P" in assembly line position indicates "Lead-Free"



Data and specifications subject to change without notice.

International **ICR** Rectifier

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